

CLC115

Quad, Closed-Loop Monolithic Buffer

General Description

The CLC115 is a high performance, closed-loop, quad buffer designed for high density applications requiring a low-cost-per-channel solution to buffering high-frequency signals. The CLC115's high performance includes a 700MHz small signal bandwidth (0.5Vpp) and a 2700V/ μ s slew rate while requiring only 11mA quiescent current per channel. Signal fidelity is maintained with low harmonic distortion (-62 dBc 2nd and 3rd harmonics at 20MHz), and wide channel separation (60dB crosstalk at 10MHz).

Featuring a unique closed-loop design, the CLC115 offers true unity-gain stability and very low output impedance plus a 60mA per channel output drive capability. The CLC115 is ideally suited for buffering video signals with its 0.08%/0.04° differential gain and phase performance at 3.58MHz. Applications such as analog multiplexing and high-speed A/D converters will benefit from the CLC115's high signal fidelity.

The CLC115 offers a low-cost-per-channel solution to high-speed buffering with four high-performance, closed-loop buffers integrated in one 14-pin package.

Constructed using an advanced, complimentary bipolar process and National's proven current feedback architectures, the CLC115 is available in several versions to meet a variety of requirements.

| | | |
|-----------|-----------------|--|
| CLC115AJP | -40°C to +85°C | 8-pin plastic DIP |
| CLC115AJE | -40°C to +85°C | 8-pin plastic SOIC |
| CLC115ALC | -40°C to +85°C | dice |
| CLC115AMC | -55°C to +125°C | dice qualified to Method 5008, MIL-STD-883, Level B MIL-STD-883, Level B |

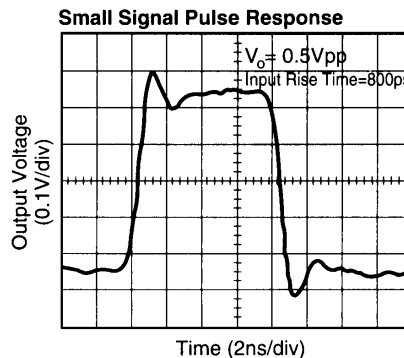
Contact factory for other packages and DESC SMD number.

Features

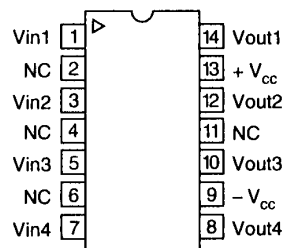
- Closed-loop, quad buffer
- 700MHz small-signal bandwidth
- 270V/ μ s slew rate
- 0.08%/0.04° differential gain/phase
- 60dB channel isolation (10MHz)
- -62dBc 2nd and 3rd harmonics at 20MHz
- 60mA current output per channel

Applications

- Multi-channel video distribution
- Video switching buffers
- High-speed analog multiplexing
- Channelized EW
- High-density buffering
- Instrumentation amps
- Active filters



Pinout



CLC115 Electrical Characteristics ($V_{cc} = \pm 5V, R_L = 100\Omega$; unless specified)

| PARAMETERS | CONDITIONS | TYP | MAX AND MIN RATINGS | | | UNITS | SYMBOL |
|--------------------------------------|--------------------------------|-------|---------------------|-------|-------|--------------------|--------|
| | | | -40°C | +25°C | +85°C | | |
| Ambient Temperature | CLC115AJ | +25°C | -40°C | +25°C | +85°C | | |
| FREQUENCY DOMAIN RESPONSE | | | | | | | |
| -3dB bandwidth | $V_{out} < 0.5V_{pp}$ | 700 | 400 | 400 | 300 | MHz | SSBW |
| | $V_{out} < 4V_{pp}$ | 270 | 200 | 200 | 150 | MHz | LSBW |
| gain flatness | $V_{out} < 0.5V_{pp}$ | | | | | | |
| flatness | DC to 30MHz ¹ | ±0.0 | ±0.1 | ±0.1 | ±0.1 | dB | GFL |
| peaking | 30MHz to 200MHz | 0.4 | 1.4 | 1.0 | 1.0 | dB | GFPH |
| rolloff | 30MHz to 200MHz | 0.0 | 0.5 | 0.5 | 0.5 | dB | GFRH |
| differential gain | 4.43MHz, 150Ω load | 0.08 | 0.25 | 0.15 | 0.15 | % | DG |
| differential phase | 4.43MHz, 150Ω load | 0.04 | 0.08 | 0.08 | 0.08 | ° | DP |
| Crosstalk (all hostile) | 10MHz | 60 | 57 | 57 | 57 | dB | XT |
| TIME DOMAIN RESPONSE | | | | | | | |
| rise and fall time | 4V step | 1.4 | 2.0 | 2.0 | 2.4 | ns | TRS |
| settling time to 0.1% | 2V step | 12 | 17 | 17 | 17 | ns | TS |
| overshoot | 4V step input $t_{rise} < 4ns$ | 5 | 15 | 12 | 12 | % | OS1 |
| | input $t_{rise} > 4ns$ | 0 | 2 | 2 | 2 | % | OS2 |
| slew rate | | 2700 | 2200 | 2200 | 1800 | V/μs | SR |
| DISTORTION AND NOISE RESPONSE | | | | | | | |
| 2nd harmonic distortion | $2V_{pp}$, 20MHz | -62 | -45 | -47 | -47 | dBc | HD2 |
| 3rd harmonic distortion | $2V_{pp}$, 20MHz | -62 | -53 | -53 | -50 | dBc | HD3 |
| equivalent noise input | | | | | | | |
| noise floor | >1MHz | -157 | -155 | -155 | -154 | dBm _{1Hz} | SNF |
| STATIC DC PERFORMANCE | | | | | | | |
| small signal gain | no load | 0.995 | 0.97 | 0.99 | 0.99 | V/V | GA |
| integral endpoint linearity | ±2V, full scale | 0.2 | 1.4 | 0.5 | 0.5 | % | ILIN |
| *output offset voltage | | ±2 | ±17 | ±9 | ±9 | mV | VIO |
| average temperature coefficient | | ±25 | ±100 | - | ±50 | μV/°C | DVIO |
| *input bias current | | ±8 | ±35 | ±20 | ±20 | μA | IBN |
| average temperature coefficient | | ±66 | ±187 | - | ±125 | nA/°C | DIBN |
| power supply rejection ratio | | 54 | 46 | 48 | 46 | dB | PSRR |
| *supply current | total, no load | 45 | 61 | 61 | 61 | mA | ICC |
| MISCELLANEOUS PERFORMANCE | | | | | | | |
| input resistance | | 750 | 100 | 450 | 450 | kΩ | RIN |
| input capacitance | | 1.6 | 2.2 | 2.2 | 2.2 | pF | CIN |
| output resistance | DC | 1.1 | 4.5 | 2.0 | 2.0 | Ω | RO |
| output voltage range | no load | ±4.0 | ±3.8 | ±3.9 | ±3.9 | V | VO |
| output voltage range | $R_L = 100\Omega$ | ±3.7 | ±2.2 | ±3.4 | ±3.0 | V | VOL |
| output current | | ±60 | ±25 | ±48 | ±30 | mA | IO |

Min/max ratings are based on product characterization and simulation. Individual parameters are tested as noted. Outgoing quality levels are determined from tested parameters.

Absolute Maximum Ratings

| | |
|-------------------------------------|--|
| V_{cc} | ±7V |
| I_{out} | output is short circuit protected to ground, however, maximum reliability is obtained if I_{out} does not exceed... 80mA |
| input voltage | ± V_{cc} |
| maximum junction temperature | +150°C |
| operating temperature range | |
| AJ: | -40°C to +85°C |
| storage temperature range | -65°C to +150°C |
| lead temperature (soldering 10 sec) | +300°C |
| ESD | ≥4000V |

Miscellaneous Ratings

NOTES:

- * AJ 100% tested at +25°C.
- note 1: Specification is guaranteed for ($50\Omega \leq R_L \leq 200\Omega$).

Package Thermal Resistance

| Package | θ_{JC} | θ_{JA} |
|---------------------|---------------|---------------|
| Plastic (AJP) | 55°C/W | 105°C/W |
| Surface Mount (AJE) | 45°C/W | 115°C/W |

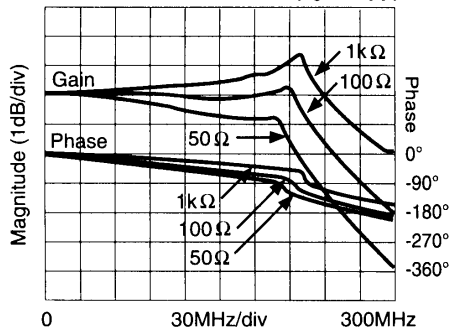
Reliability Information

Transistor Count

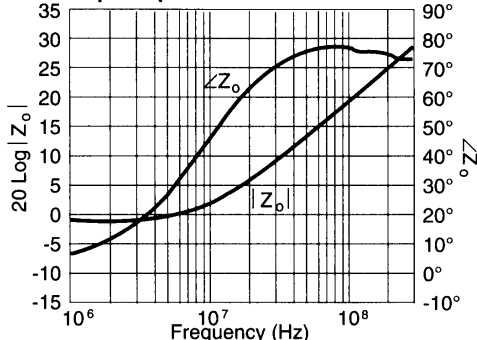
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CLC115 Typical Performance Characteristics ($T_A = +25^\circ$, $V_{CC} = \pm 5V$, $R_L = 100\Omega$; unless specified)

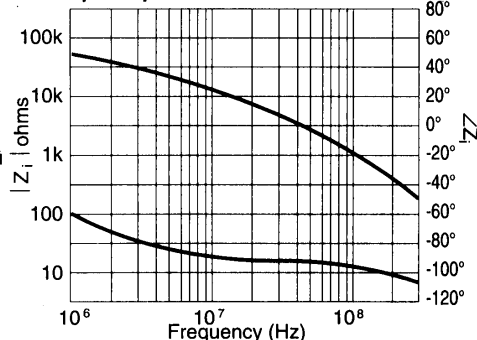
Gain and Phase vs. Load ($V_o = 4V_{pp}$)



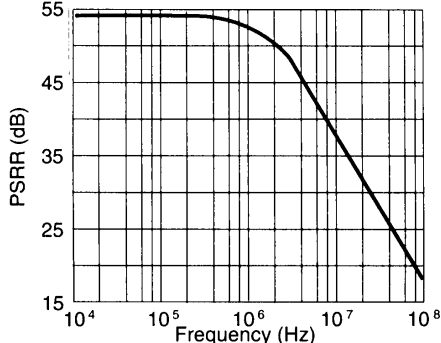
Output Impedance



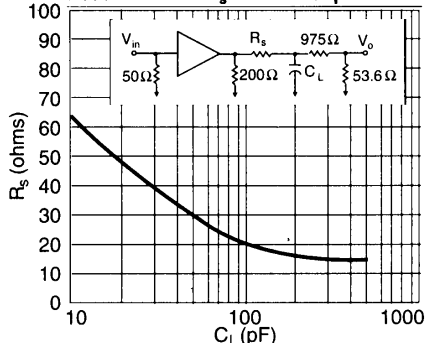
Input Impedance



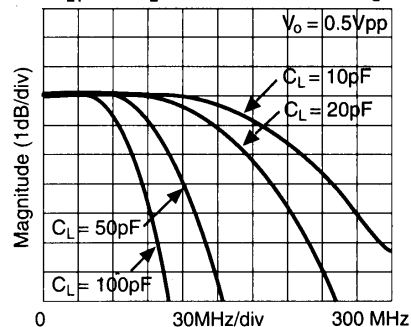
PSRR



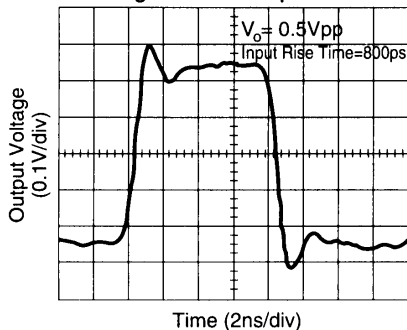
Recommended R_s vs. Load Capacitance



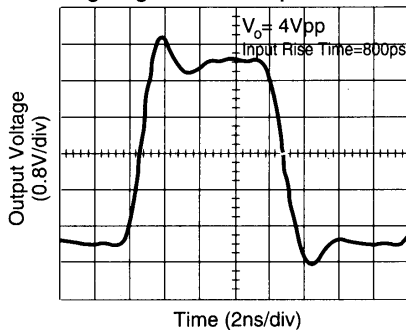
$|S_{21}|$ vs. C_L with Recommended R_s



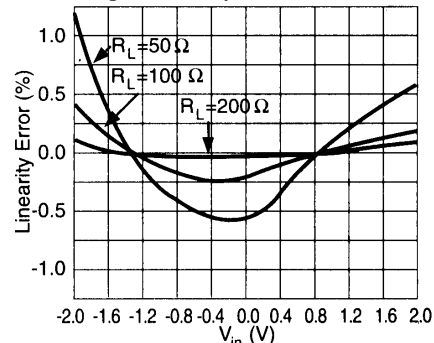
Small Signal Pulse Response



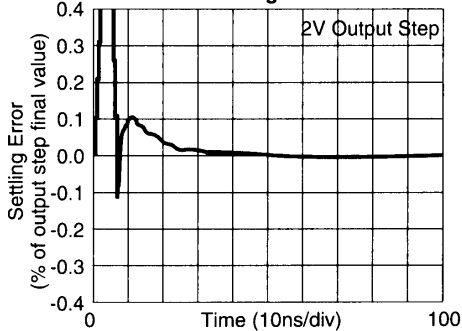
Large Signal Pulse Response



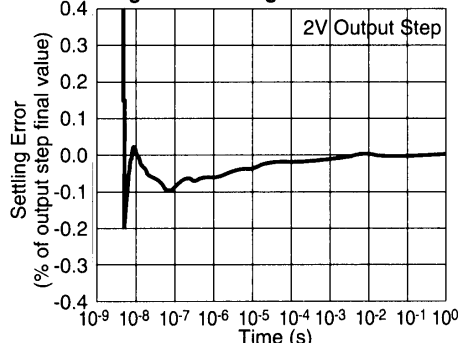
Integral Linearity Error



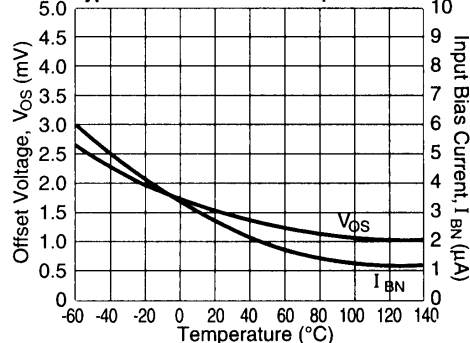
Short-Term Settling Time



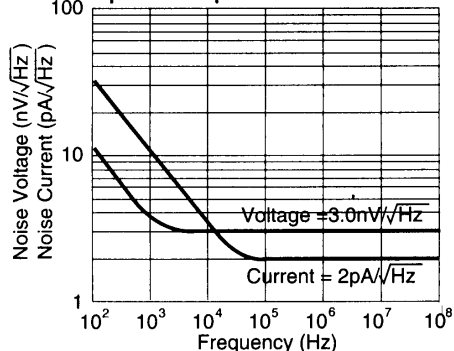
Long-Term Settling Time



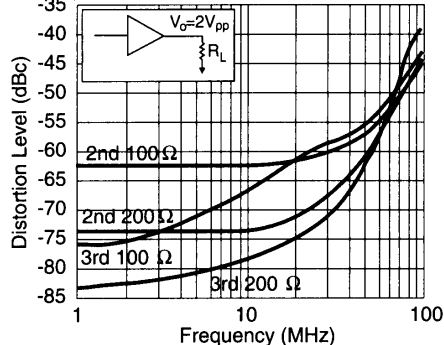
Typical D.C. Errors vs. Temperature



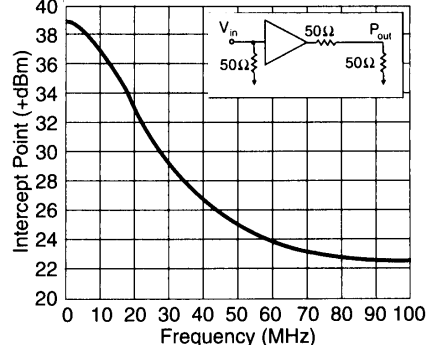
Equivalent Input Noise



2nd and 3rd Harmonic Distortion



2-Tone, 3rd Order Intermodulation Intercept



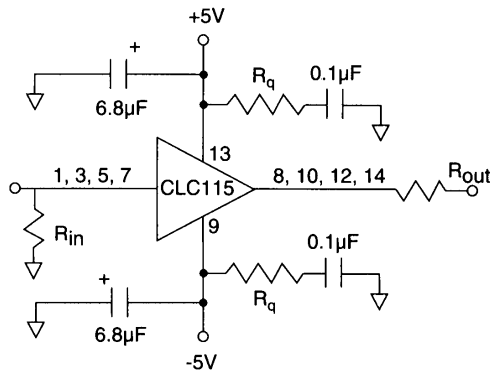


Figure 1: recommended circuit

PC Board Layout and Circuit Design

For optimum performance, high frequency devices demand a good printed circuit board layout. A ground plane and power supply bypassing with good high-frequency ceramic capacitors in close proximity to the supply pins is essential. Second harmonic distortion can be improved by ensuring equal current return paths for both the positive and negative supplies.

The dominant pole, i.e. the high-frequency compensation of the CLC115, is set by the load resistance, R_L . Ideally, each buffer of the CLC115 should see a 100Ω load at high frequency to ensure stability. An unterminated channel is undercompensated and will exhibit gain at several hundred megahertz. Signal coupling may occur between channels through the common power supply connections. Any resonance in the power supply can lead to oscillations in the unterminated or undercompensated channel.

In order to compensate and to guarantee the stability of the four CLC115 channels, each must be terminated with a 100Ω resistance to ground. If a dc load is not desired, a two picofarad capacitor can be inserted between the 100Ω load resistor and ground, as shown in Figure 2.

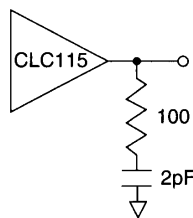


Figure 2: AC load

If the above load conditions are not feasible for your design, the power supply resonance must be addressed. Chip capacitors have less parasitic inductance than leaded ceramic capacitors. The use of 0.1µF chip capacitors mounted immediately adjacent to the power supply pins eliminates the resonance which can lead to oscillations. If chip capacitors are not used, then the only other means to eliminate the possibility of oscillation caused by power supply resonance is to 'de-Q' the resonant structure. 'De-Q'ing is particularly necessary while using leaded capacitors and can be achieved by inserting a 10Ω resistor, R_q , in series with the 0.1µF bypass capacitor, as shown in Figure 1. The insertion of the 'de-Q'ing resistor will reduce frequency response peaking as well as the tendency toward oscillation when driving a load resistance greater than 100Ω, but will increase harmonic distortion by approximately 2dB.

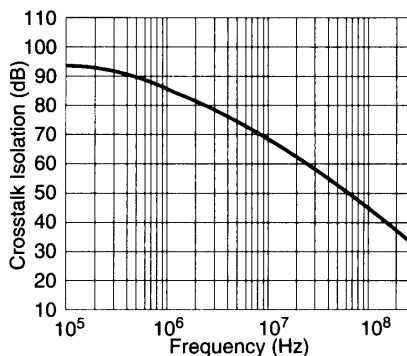


Figure 3: all-hostile crosstalk isolation

Crosstalk is strongly dependent on board layout. Closely spaced signal traces on the circuit board will degrade crosstalk due to intertrace capacitance. It is recommended that unused package pins (2,4,6,11) be connected to the ground plane for better isolation at the device pins. Similarly, crosstalk can be improved by using a grounded guard-trace between signal lines. This will reduce the distributed capacitance between signal lines.

Two graphs show the effects of crosstalk. All-hostile crosstalk is measured by driving three of the four buffers simultaneously while observing the fourth, undriven channel. Figure 3, "All-Hostile Crosstalk Isolation", shows this effect as a function of input signal frequency. The load for all four channels of the CLC115 is 100Ω. Figure 4, "Most Susceptible Channel-to-Channel Pulse Coupling", describes one effect of crosstalk when one channel is driven with a 4V_{pp} step ($t_r=5ns$) while the output of the undriven channel is measured. From Figure 3 it can be seen that crosstalk improves as the signal frequency is reduced. Similarly, the pulse coupling crosstalk will improve as the time increases.

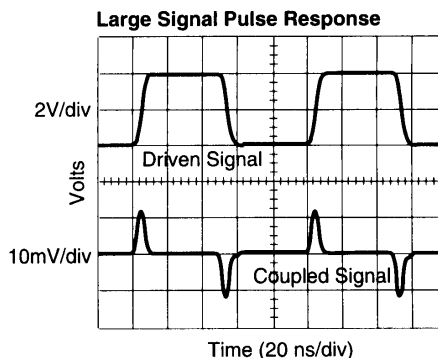


Figure 4: most susceptible channel-to-channel pulse coupling

Unused Buffers

The output of any unused buffers must be terminated in 100Ω to ground, as discussed above. It is recommended that unused buffer inputs be terminated in 50Ω to ground.

Evaluation Board

An evaluation board for the CLC115 is available. This board may be ordered as part CLC730023.

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